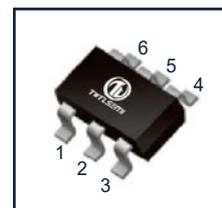


## Description

The BSS138PS is a dual N-channel enhanced MOS field-effect transistor. Uses advanced trench technology and design to provide excellent  $R_{os}(ow)$ , with low gate charge. Device is suitable for use in DC-DC conversion, power switch and charging circuit.

## General Features

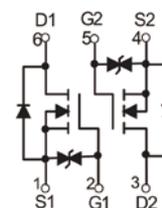
- High density cell design for extremely low  $R_{DS}(on)$
- Rugged and Reliable



SOT-363

## Applications

- Direct Logic-Level Interface: TTL/CMOS
- Battery Operated Systems
- Solid-State Relays



Equivalent Circuit

## Ordering information

Product ID	Pack	Naming rule	Marking	Qty(PCS)
BSS138PS	SOT-363	<div style="border: 1px solid black; padding: 5px; display: inline-block;">           BSS138PS            ↓            产品名称            product name         </div>	SS	3000

## Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source voltage	50	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current-Continuous	0.3	A
$P_D$	Power Dissipation	150	mW
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	833	$^{\circ}\text{C}/\text{W}$
$T_J$	Junction Temperature	150	$^{\circ}\text{C}$
$T_{stg}$	Storage Temperature	-55~+150	$^{\circ}\text{C}$

## Electrical Characteristics (TA=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>STATIC CHARACTERISTICS</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	50	---	---	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V	---	---	0.5	μA
I <sub>GSS</sub>	Gate -Source leakage current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	0.5	μA
V <sub>GS(th)</sub>	GateThreshold Voltage <sup>1</sup>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =1mA	0.8	1.2	1.5	V
R <sub>DS(on)</sub>	Drain-Source On-Resistance <sup>1</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =220mA	---	1.9	3.5	Ω
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =220mA	---	2	6.0	
g <sub>fs</sub>	Forward Transconductance <sup>1</sup>	V <sub>DS</sub> =10V, I <sub>D</sub> =220mA	---	0.15	---	mS
<b>DYNAMIC CHARACTERISTICS<sup>2</sup></b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	---	26.5	---	pF
C <sub>oss</sub>	Output Capacitance		---	12.9	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	5.9	---	
<b>SWITCHING CHARACTERISTICS<sup>1,2</sup></b>						
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =30V, I <sub>D</sub> =290mA, V <sub>GS</sub> =10V, R <sub>G</sub> =6Ω	---	---	5	ns
T <sub>r</sub>	Rise Time		---	---	18	
T <sub>d(off)</sub>	Turn-Off Delay Time		---	---	36	
T <sub>f</sub>	Fall Time		---	---	14	
<b>SOURCE-DRAIN DIODE CHARACTERISTICS<sup>1</sup></b>						
V <sub>DS</sub>	Diode Forward voltage	I <sub>S</sub> =440mA, V <sub>GS</sub> =0V	---	---	1.4	V

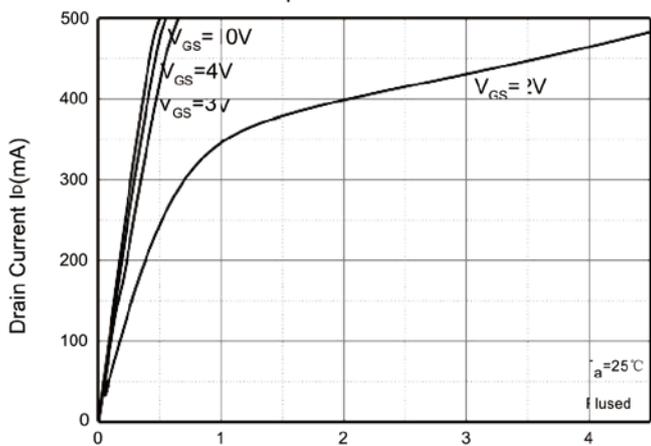
**Notes:**

1. Pulse Test ; Pulse Width ≤300μs, Duty Cycle ≤2%.
2. These parameters have no way to verify.



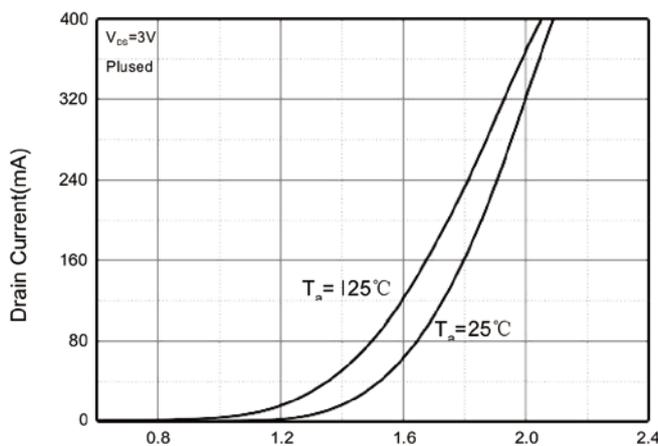
## Typical Characteristics

Output Characteristics



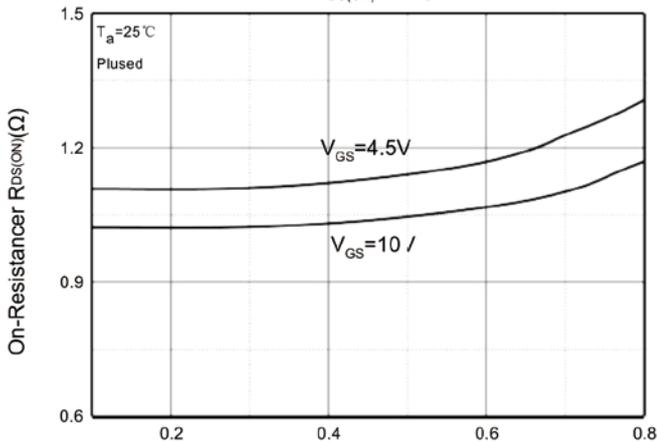
DRAIN TO SOURCE VOLTAGE  $V_{DS}(V)$

Transfer Characteristics



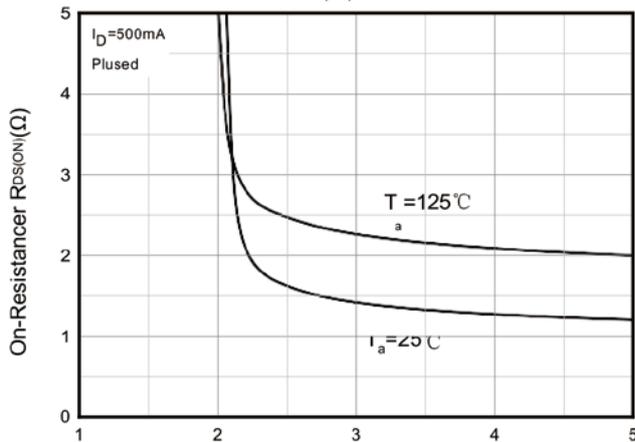
GATE TO SOURCE VOLTAGE  $V_{GS}(V)$

$R_{DS(ON)} - I_D$



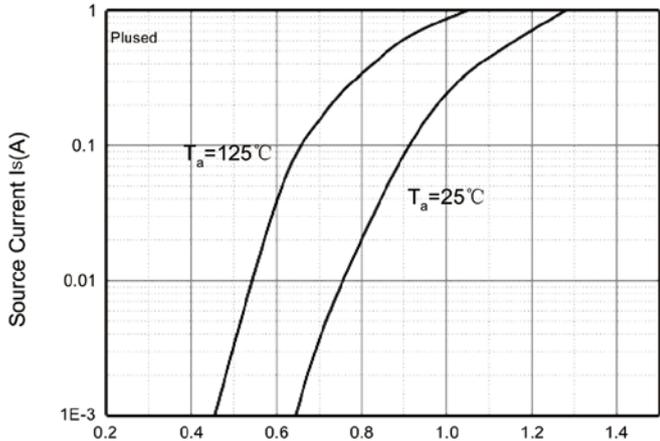
DRAIN CURRENT  $I_D(A)$

$R_{DS(ON)} - V_{GS}$



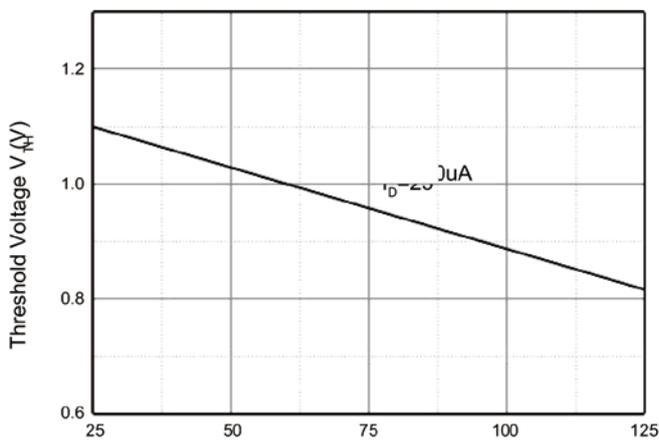
GATE TO SOURCE VOLTAGE  $V_{GS}(V)$

$I_S - V_{SD}$



SOURCE TO DRAIN VOLTAGE  $V_{SD}(V)$

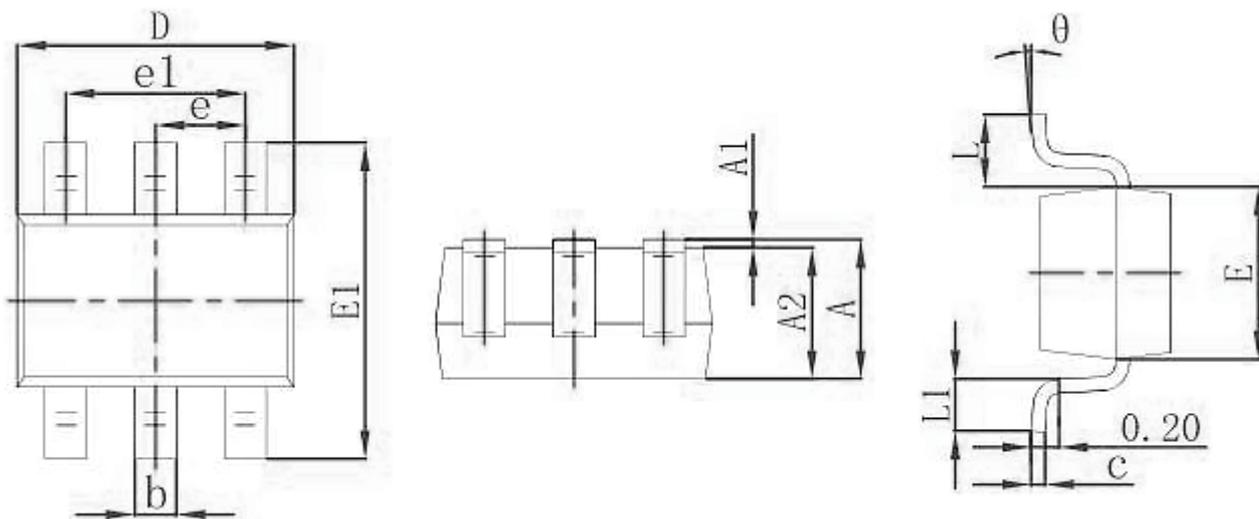
Threshold Voltage



JUNCTION TEMPERATURE  $T_J(^\circ C)$



## SOT-363 Package Outline Dimensions



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.100	0.150	0.004	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
$\theta$	0°	8°	0°	8°